Stackpole Electronics, Inc.

General Purpose Metal Oxide Resistor

Resistive Product Solutions

Features:

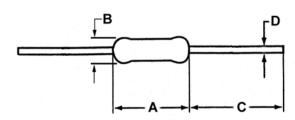
- Lower-cost alternative to carbon comps and wirewounds
- Coating meets UL 94V-0
- Meets solvent test of Mil Standard 202, Method 215
- Cut and formed product is available on select sizes contact Stackpole for details
- Higher or lower resistance values may be possible contact Stackpole
- Flameproof
- RoHS compliant, lead free and halogen free



	Electrical Specifications								
Type / Code	Power Rating	Maximum Working	Maximum Overload	Dielectric Withstanding	TCR (ppm/°C)	Ohmic Range (Ω) and Tolerance			
	(W) @ 70 °C	Voltage (V) ⁽¹⁾	Voltage (V)	Voltage (V)		1%	2%	5%	
RSF12	0.5	250	400	350	± 200	0.1 - 150 K	0.1 - 75 K	0.1 - 1 M	
RSF1	1	350	600	600	± 200	0.1 - 100 K		0.1 - 1 M	
RSF2	2	350	600	600	± 200	0.1 - 120 K		0.1 - 1 M	
RSF3	3	800	1000	750	± 200	0.1 - 470 K	0.1 - 560 K	0.1 - 1 M	
RSF5	5	1000	1000	750	± 200	0.1 - 470 K	0.1 - 560 K	0.1 - 1 M	
RSMF12	0.5	250	400	350	± 200	0.1 - 46.4 K	0.1 - 47 K	0.1 - 470 K	
RSMF1	1	350	600	500	± 200	0.1 - 75 K		0.1 - 470 K	
RSMF2	2	350	600	500	± 200	0.1 - 100 K		0.1 - 470 K	
RSMF3	3	500	800	600	± 200	0.1 - 118 K	0.1 - 120 K	0.1 - 470 K	
RSMF5	5	1000	1000	750	± 200	0.1 - 470 K	0.1 - 560 K	0.1 - 1 M	

(1) Lesser of √P*R or maximum working voltage

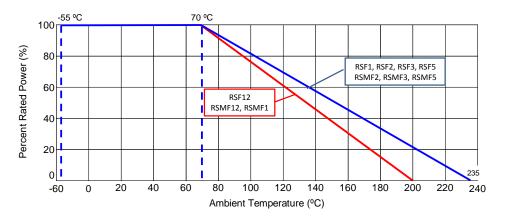
Mechanical Specifications

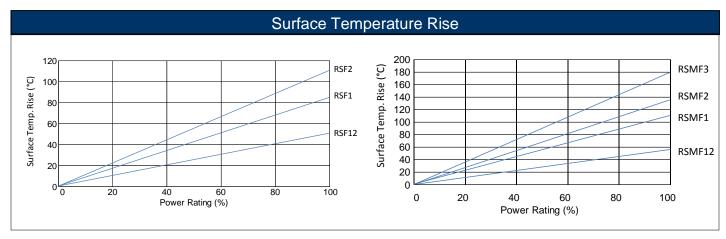


Tuna / Cada	A	В	C	D	Lead-Tape	Unit
Type / Code	Body Length	Body Diameter	Lead Length (Bulk)	Lead Diameter	Specification	Unit
RSF12	0.35 ± 0.04	0.13 ± 0.03	1.10 ± 0.12	0.03 ± 0.003	0.250	inches
KOI 12	9.00 ± 1.00	3.20 ± 0.80	28.00 ± 3.00	0.70 ± 0.08	6.35	mm
RSF1	0.43 ± 0.06	0.18 ± 0.04	1.10 ± 0.20	0.03 ± 0.002	0.250	inches
KOFI	11.00 ± 1.50	4.50 ± 1.00	28.00 ± 5.00	0.80 ± 0.05	6.35	mm
RSF2	0.59 ± 0.06	0.22 ± 0.04	1.18 ± 0.20	0.03 ± 0.004	0.250	inches
ROFZ	15.00 ± 1.50	5.50 ± 1.00	30.00 ± 5.00	0.75 ± 0.10	6.35	mm
RSF3	0.69 ± 0.04	0.24 ± 0.02	1.38 ± 0.12	0.03 ± 0.002	0.250	inches
KOI 3	17.50 ± 1.00	6.00 ± 0.50	35.00 ± 3.00	0.80 ± 0.05	6.35	mm
RSF5	0.96 ± 0.04	0.31 ± 0.02	1.38 ± 0.12	0.03 ± 0.002	0.250	inches
KOI J	24.50 ± 1.00	8.00 ± 0.50	35.00 ± 3.00	0.80 ± 0.05	6.35	mm
RSMF12	0.24 ± 0.03	0.09 ± 0.01	1.10 ± 0.12	0.02 ± 0.003	0.250	inches
KOWII 12	6.00 ± 0.80	2.30 ± 0.30	28.00 ± 3.00	0.55 ± 0.07	6.35	mm
RSMF1	0.35 ± 0.04	0.13 ± 0.03	1.10 ± 0.12	0.03 ± 0.003	0.250	inches
KOWI I	9.00 ± 1.00	3.20 ± 0.80	28.00 ± 3.00	0.70 ± 0.08	6.35	mm
RSMF2	0.43 ± 0.06	0.18 ± 0.04	1.18 ± 0.20	0.03 ± 0.002	0.250	inches
NOIVII Z	11.00 ± 1.50	4.50 ± 1.00	30.00 ± 5.00	0.80 ± 0.05	6.35	mm
RSMF3	0.59 ± 0.06	0.22 ± 0.04	1.18 ± 0.20	0.03 ± 0.004	0.250	inches
KOWI 3	15.00 ± 1.50	5.50 ± 1.00	30.00 ± 5.00	0.75 ± 0.10	6.35	mm
RSMF5	0.69 ± 0.04	0.24 ± 0.02	1.38 ± 0.08	0.03 ± 0.002	0.250	inches
KOMEO	17.50 ± 1.00	6.00 ± 0.50	35.00 ± 2.00	0.80 ± 0.05	6.35	mm

Resistive Product Solutions

Power Derating Curve:





Insulation Resistance JIS C5201-1, IEC60115-1, 4.6 ≥ 1 G Ω ≥ 1 G Ω Voltage Proof JIS C5201-1, IEC60115-1, 4.7 ≤ ± (0.5% + 0.05 Ω) No mechanical damage. < ± 0.25% Short Time Overload JIS C5201-1, IEC60115-1, 4.13 ≤ ± (0.75% + 0.05 Ω) < ± 0.1% Resistance to Solder Heat JIS C5201-1, IEC60115-1, 4.18 ≤ ± (2.0% + 0.05 Ω) < ± 1.0% Endurance at 70 °C JIS C5201-1, IEC60115-1, 4.25.1 ≤± (5.0% + 0.05 Ω) < ± 2.0% Robustness of Terminations JIS C5201-1, IEC60115-1, 4.16 ≤ ± (1.0% + 0.05 Ω) < ± 0.10% Damp Heat (Steady state) JIS C5201-1, IEC60115-1, 4.24 ≤± (5% + 0.05 Ω) < ± 1.5% Rapid Change of Temperature JIS C5201-1, IEC60115-1, 4.19 ≤± (1% + 0.05 Ω) < ± 0.2%	Performance Characteristics								
Voltage Proof JIS C5201-1, IEC60115-1, 4.7 $\leq \pm (0.5\% + 0.05 \Omega)$ No mechanical damage. $< \pm 0.25\%$ Short Time Overload JIS C5201-1, IEC60115-1, 4.13 $\leq \pm (0.75\% + 0.05 \Omega)$ $< \pm 0.1\%$ Resistance to Solder Heat JIS C5201-1, IEC60115-1, 4.18 $\leq \pm (2.0\% + 0.05 \Omega)$ $< \pm 1.0\%$ Endurance at 70 °C JIS C5201-1, IEC60115-1, 4.25.1 $\leq \pm (5.0\% + 0.05 \Omega)$ $< \pm 2.0\%$ Robustness of Terminations JIS C5201-1, IEC60115-1, 4.16 $\leq \pm (1.0\% + 0.05 \Omega)$ $< \pm 0.10\%$ Damp Heat (Steady state) JIS C5201-1, IEC60115-1, 4.24 $\leq \pm (5\% + 0.05 \Omega)$ $< \pm 1.5\%$ Rapid Change of Temperature JIS C5201-1, IEC60115-1, 4.19 $\leq \pm (1\% + 0.05 \Omega)$ $< \pm 0.2\%$	Test	Test Method	Test Spec	Typical Results					
Short Time Overload JIS C5201-1, IEC60115-1, 4.13 $\leq \pm (0.75\% + 0.05 \Omega)$ $< \pm 0.1\%$ Resistance to Solder Heat JIS C5201-1, IEC60115-1, 4.18 $\leq \pm (2.0\% + 0.05 \Omega)$ $< \pm 1.0\%$ Endurance at 70 °C JIS C5201-1, IEC60115-1, 4.25.1 $\leq \pm (5.0\% + 0.05 \Omega)$ $< \pm 2.0\%$ Robustness of Terminations JIS C5201-1, IEC60115-1, 4.16 $\leq \pm (1.0\% + 0.05 \Omega)$ $< \pm 0.10\%$ Damp Heat (Steady state) JIS C5201-1, IEC60115-1, 4.24 $\leq \pm (5\% + 0.05 \Omega)$ $< \pm 1.5\%$ Rapid Change of Temperature JIS C5201-1, IEC60115-1, 4.19 $\leq \pm (1\% + 0.05 \Omega)$ $< \pm 0.2\%$	Insulation Resistance	JIS C5201-1, IEC60115-1, 4.6	≥ 1 G	≥ 1 G Ω					
Resistance to Solder Heat JIS C5201-1, IEC60115-1, 4.18 $\leq \pm (2.0\% + 0.05 \Omega)$ $< \pm 1.0\%$ Endurance at 70 °C JIS C5201-1, IEC60115-1, 4.25.1 $\leq \pm (5.0\% + 0.05 \Omega)$ $< \pm 2.0\%$ Robustness of Terminations JIS C5201-1, IEC60115-1, 4.16 $\leq \pm (1.0\% + 0.05 \Omega)$ $< \pm 0.10\%$ Damp Heat (Steady state) JIS C5201-1, IEC60115-1, 4.24 $\leq \pm (5\% + 0.05 \Omega)$ $< \pm 1.5\%$ Rapid Change of Temperature JIS C5201-1, IEC60115-1, 4.19 $\leq \pm (1\% + 0.05 \Omega)$ $< \pm 0.2\%$	Voltage Proof	JIS C5201-1, IEC60115-1, 4.7	$\leq \pm (0.5\% + 0.05 \Omega)$	\leq ± (0.5% + 0.05 Ω) No mechanical damage.					
Endurance at 70 °C JIS C5201-1, IEC60115-1, 4.25.1 $\leq \pm (5.0\% + 0.05 \Omega)$ $< \pm 2.0\%$ Robustness of Terminations JIS C5201-1, IEC60115-1, 4.16 $\leq \pm (1.0\% + 0.05 \Omega)$ $< \pm 0.10\%$ Damp Heat (Steady state) JIS C5201-1, IEC60115-1, 4.24 $\leq \pm (5\% + 0.05 \Omega)$ $< \pm 1.5\%$ Rapid Change of Temperature JIS C5201-1, IEC60115-1, 4.19 $\leq \pm (1\% + 0.05 \Omega)$ $< \pm 0.2\%$	Short Time Overload	JIS C5201-1, IEC60115-1, 4.13	≤ ± (0.75% + 0.05 Ω)		< ± 0.1%				
Robustness of Terminations JIS C5201-1, IEC60115-1, 4.16 $\leq \pm (1.0\% + 0.05 \Omega)$ $< \pm 0.10\%$ Damp Heat (Steady state) JIS C5201-1, IEC60115-1, 4.24 $\leq \pm (5\% + 0.05 \Omega)$ $< \pm 1.5\%$ Rapid Change of Temperature JIS C5201-1, IEC60115-1, 4.19 $\leq \pm (1\% + 0.05 \Omega)$ $< \pm 0.2\%$	Resistance to Solder Heat	JIS C5201-1, IEC60115-1, 4.18	$\leq \pm (2.0\% + 0.05 \Omega)$		< ± 1.0%				
Damp Heat (Steady state) JIS C5201-1, IEC60115-1, 4.24 $≤±$ (5% + 0.05 Ω) $<±$ 1.5% Rapid Change of Temperature JIS C5201-1, IEC60115-1, 4.19 $≤±$ (1% + 0.05 Ω) $<±$ 0.2%	Endurance at 70 °C	JIS C5201-1, IEC60115-1, 4.25.1	≤± (5.0% + 0.05 Ω)		< ± 2.0%				
Rapid Change of Temperature JIS C5201-1, IEC60115-1, 4.19 $≤ ± (1\% + 0.05 Ω)$ $< ± 0.2\%$	Robustness of Terminations	JIS C5201-1, IEC60115-1, 4.16	$\leq \pm (1.0\% + 0.05 \Omega)$		< ± 0.10%				
	Damp Heat (Steady state)	JIS C5201-1, IEC60115-1, 4.24	≤± (5% + 0.05 Ω)		< ± 1.5%				
Desistance to Columnta IIC 05004.4 IEC00445.4 4.00 No demand to company of a compan	Rapid Change of Temperature	JIS C5201-1, IEC60115-1, 4.19	≤± (1% +	0.05 Ω)	< ± 0.2%				
Resistance to Solvents JIS C5201-1, IEC00115-1, 4.29 No damage to component or removal of marking. Pass	Resistance to Solvents	JIS C5201-1, IEC60115-1, 4.29	No damage to component or removal of marking.		Pass				
Intermittent Overload JIS C5201-1, IEC60115-1, 4.39 $\leq \pm (2\% + 0.05 \Omega)$ $< \pm 0.3\%$	Intermittent Overload	JIS C5201-1, IEC60115-1, 4.39	≤± (2% + 0.05 Ω)		$< \pm 0.3\%$				
Accidental Overload (Flame resistance)	Accidental Overload (Flame resistance)	JIS C5201-1, IEC60115-1, 4.26	No flaming of gauze.		Pass				

Operating temperature range is -55 $^{\circ}$ C to +200 $^{\circ}$ C (RSF12, RSMF1), -55 $^{\circ}$ C to +235 $^{\circ}$ C (all others)

Repetitive Pulse Information:

If repetitive pulses are applied to resistors, pulse wave form must be less than "pulse limiting voltage", "pulse limiting current" or "pulse limiting wattage" calculated by the formula below.

 $\begin{array}{rcl} Vp & = & K \sqrt{P \times R \times T/t} \\ Ip & = & K \sqrt{P/R \times T/t} \\ Pp & = & K^2 \times P \times T/t \end{array}$

Stackpole Electronics, Inc.

Vp(lp) or Pp

Resistive Product Solutions

Where: Vp: Pulse limiting voltage (V)
lp: Pulse limiting current (A)

General Purpose Metal Oxide Resistor

Pp: Pulse limiting wattage (W)

P: Power rating (W)

R: Nominal resistance (ohm)
T: Repetitive period (sec)
t: Pulse duration (sec)

K: Coefficient: 0.8

[Vr: Rated Voltage (V), Ir: Rated Current (A)]



Note 2: If T > 10 and T/t > 1000, "Pulse Limiting power (Single pulse) is applied

Note 3: If Vp < Vr (lp < lr or Pp < P), Vr (lr, P) is Vp (lp, Pp)

Note 4: Pulse limiting voltage (current, wattage) is applied at less than rated ambient temperature. If ambient temperature is more than the rated temperature (70 °C), decrease power rating according to "Power Derating Curve"

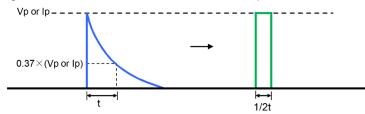
Note 5: Assure sufficient margin for use period and conditions for "pulse limiting voltage"

Note 6: If the pulse waveform is not square wave, judge after transform the waveform into square

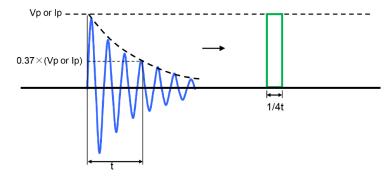
wave according to the "Waveform Transformation to Square Wave".

Waveform Transformation to Square Wave

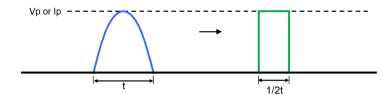
1. Discharge curve wave with time constant "t" → Square wave



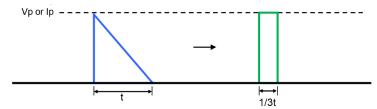
2. Damping oscillation wave with time constant of envelope "t" → Square wave



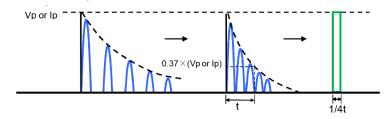
3. Half-wave rectification wave → Square wave



4. Triangular wave → Square wave



5. Special wave → Square wave



Points are cut at dotted line for 10° (25mm) reel only

Replad in	accordance	with	FIA-206-F
Reelea in	accordance	WILLI	EIA-290-F

Type / Code	A max ⁽¹⁾	B max	С	D ⁽²⁾	Tape	Unit
RSF12	2.736	13.504	0.197 ± 0.020	2.063 ± 0.079	0.250	inches
101 12	69.50	343.00	5.00 ± 0.50	52.40 ± 2.00	6.35	mm
RSF1	2.815	13.504	0.197 ± 0.020	2.063 ± 0.079	0.250	inches
Kori	71.50	343.00	5.00 ± 0.50	52.40 ± 2.00	6.35	mm
RSF2	3.524	13.504	0.394 ± 0.020	2.500 ± 0.079	0.250	inches
KOFZ	89.50	343.00	10.00 ± 0.50	63.50 ± 2.00	6.35	mm
RSF3	3.740	12.008	0.394 ± 0.020	2.874 ± 0.079	0.250	inches
Koro	95.00	305.00	10.00 ± 0.50	73.00 ± 2.00	6.35	mm
RSF5	4.331	12.008	0.394 ± 0.020	3.465 ± 0.079	0.250	inches
Koro	110.00	305.00	10.00 ± 0.50	88.00 ± 2.00	6.35	mm
Type / Code	A max ^{.(1)}	B max	С	D ⁽²⁾	Tape	Unit
RSMF12	2.618	13.504	0.197 ± 0.020	2.063 ± 0.079	0.250	inches
IXOIVII 12	66.50	343.00	5.00 ± 0.50	52.40 ± 2.00	6.35	mm
RSMF1	2.736	13.504	0.197 ± 0.020	2.063 ± 0.079	0.250	inches
IXOWII 1	69.50	343.00	5.00 ± 0.50	52.40 ± 2.00	6.35	mm
RSMF2	2.815	13.504	0.197 ± 0.020	2.063 ± 0.079	0.250	inches
KOWIFZ	71.50	343.00	5.00 ± 0.50	52.40 ± 2.00	6.35	mm
RSMF3	3.524	13.504	0.394 ± 0.020	2.500 ± 0.079	0.250	inches
KOWFS	89.50	343.00	10.00 ± 0.50	63.50 ± 2.00	6.35	mm
RSMF5	3.740	12.008	0.394 ± 0.020	2.874 ± 0.079	0.250	inches
KOWFS	95.00	305.00	10.00 ± 0.50	73.00 ± 2.00	6.35	mm

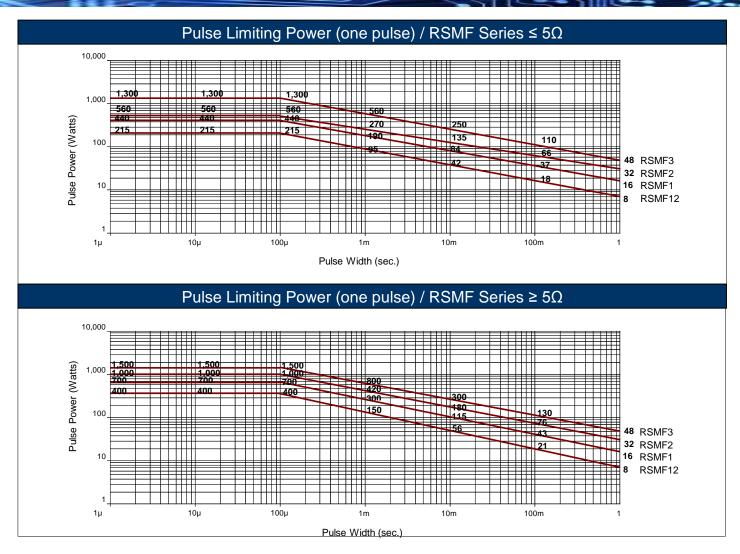
Dimension "E": This is a non-critical dimension that does not have a tolerance in the standard. Range of diameters is from 0.547 inches (13.90 mm) to 1.500 inches (38.10 mm).

- (1) Reference value only. The "A" dimension shall be governed by the overall length of the taped component. The distance between flanges shall be 0.059 inches (1.50 mm) to 0.315 (8.00 mm) greater than the overall component.
- (2) The given dimension "D" expresses the standard width spacing. A 26 mm narrow spacing is available as option "N" packaging code.

Resistive Product Solutions

Description	PRSM12	PRSF1 / PRSM2		
Body diameter	0.157 max.	0.217 max.		
Body diamotor		5.50 max.		
Body length		0.492 max.		
Body long		12.50 max.		
Mounting height		0.709 max.		
		18.00 max.		
Lead diameter		0.028 ± 0.004		
		0.70 ± 0.10		
Component pitch	0.500 ± 12.70 ±			
Feed hole pitch		± 0.012		
Feed hole center to lead		± 0.020 ± 0.50		
Food halo contante hade		± 0.016		
Feed note center to body	6.35 :	± 0.40		
Lood lood distance	0.200 -	+0.24 / -0.008		
Lead-lead distance	5.08 -	+0.60 / -0.20		
Performing angle	45° max			
	0.000	+ 0.079		
Component alignment	0.000 ± 2.00			
	0.000 ± 0.118			
Component alignment	0.00 ± 3.00			
Tono width	0.709 +0.039 / -0.031			
rape width	18.00 +1.00 / -0.80			
Hold down tone width	0.492 min.			
Hold down tape width	12.50 min.			
Hole position	0.354 ± 0.020			
Tiole position	9.00 ± 0.50			
Hold down tape position		+0 / -0.059		
rioid do iiii tapo position	2.00 +0 / -1.50			
Distance to tape center	0.748 ± 0.039			
	19.00 ± 1.00			
H0 Lead wire clinch height		0.630 ± 0.020		
		16.00 ± 0.50		
Lead wire portrait	0.039 max.			
-	1.00 max. 0.157 ± 0.008			
Feed hole diamenter				
	4.00 ± 0.20 0.028 max.			
Total tape thickness	Total tape thickness 0.028 max. 0.70 max.			
i Total tape thickness		0.70 max. 0.433 max.		
Length of shipped lead				
	Body length Mounting height Lead diameter Component pitch Feed hole pitch Feed hole center to lead Feed hole center to body Lead-lead distance Performing angle Component alignment Component alignment Tape width Hold down tape width Hole position Hold down tape center Lead wire clinch height Feed hole diamenter Total tape thickness	Body diameter		

Resistive Product Solutions



RoHS Compliance

Stackpole Electronics has joined the worldwide effort to reduce the amount of lead in electronic components and to meet the various regulatory requirements now prevalent, such as the European Union's directive regarding "Restrictions on Hazardous Substances" (RoHS 3). As part of this ongoing program, we periodically update this document with the status regarding the availability of our compliant components. All our standard part numbers are compliant to EU Directive 2011/65/EU of the European Parliament as amended by Directive (EU) 2015/863/EU as regards the list of restricted substances.

RoHS Compliance Status								
Standard Product Series	Description	Package / Termination Type	Standard Series RoHS Compliant	Lead-Free Termination Composition	Lead-Free Mfg. Effective Date (Std Product Series)	Lead-Free Effective Date Code (YY/WW)		
RSF	General Purpose Metal Oxide Leaded Resistor	Axial	YES	99.3/0.7 Sn/Cu 100% Matte Sn	Apr-05 (Japan) Jan-04 (Taiwan, China)	05/14 04/01		
RSMF	Mini-Metal Oxide Leaded Resistor	Axial	YES	99.3/0.7 Sn/Cu 100% Matte Sn	Apr-05 (Japan) Jan-04 (Taiwan, China)	05/14 04/01		

RSF / RSMF Series

General Purpose Metal Oxide Resistor

Stackpole Electronics, Inc.

Resistive Product Solutions

"Conflict Metals" Commitment

We at Stackpole Electronics, Inc. are joined with our industry in opposing the use of metals mined in the "conflict region" of the Eastern Democratic Republic of the Congo (DRC) in our products. Recognizing that the supply chain for metals used in the electronics industry is very complex, we work closely with our own suppliers to verify to the extent possible that the materials and products we supply do not contain metals sourced from this conflict region. As such, we are in compliance with the requirements of Dodd-Frank Act regarding Conflict Minerals.

Compliance to "REACH"

We certify that all passive components supplied by Stackpole Electronics, Inc. are SVHC (Substances of Very High Concern) free and compliant with the requirements of EU Directive 1907/2006/EC, "The Registration, Evaluation, Authorization and Restriction of Chemicals", otherwise referred to as REACH. Contact us for complete list of REACH Substance Candidate List.

Environmental Policy

It is the policy of Stackpole Electronics, Inc. (SEI) to protect the environment in all localities in which we operate. We continually strive to improve our effect on the environment. We observe all applicable laws and regulations regarding the protection of our environment and all requests related to the environment to which we have agreed. We are committed to the prevention of all forms of pollution.

